TMP144EVM

User's Guide

Literature Number: SNOU159
July 2018

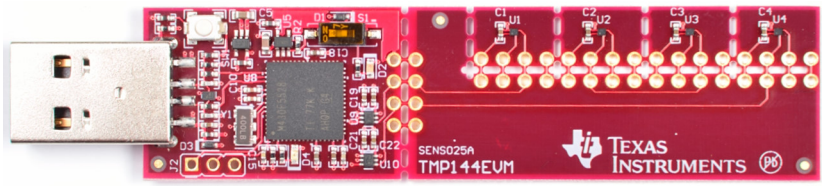
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TMP144EVM User's Guide

This user's guide describes the characteristics, operation, and use of the TMP144EVM evaluation board. This user's guide discusses how to set up and configure the software, discusses the hardware, and reviews various aspects of the software operation. Throughout this document, the terms evaluation board, evaluation module, and EVM are synonymous with the TMP144EVM. This user's guide also includes information regarding operating procedures and input and output connections, an electrical schematic, printed-circuit board (PCB) layout drawings, and a parts list for the EVM.



1 Trademarks

All trademarks are the property of their respective owners.

2 Overview

The TMP144EVM allows users to evaluate the performance of the TMP144 digital temperature sensor. The EVM comes in a USB stick form factor with an onboard MSP430F5528 microcontroller that interfaces with both the host computer and four TMP144 devices using an UART interface. The module is designed to provide user flexibility separating the sensors and host controller at the perforation on the EVM board. The perforation allows the user flexibility in their evaluation:

- The user can connect the TMP144 to the user's system/host.
- The user can connect the EVM host and software to the user's system with TMP144 devices.
- Small individual boards allow the user to place sensors in the user's system.
- Hole spacing is compatible with common 0.1" prototyping breadboards.

2.1 EVM Kit Contents

Table 1 details the contents of the EVM kit. Contact the Texas Instruments Product Information Center nearest you if components are missing. TI highly recommends that users check the TI website at http://www.ti.com to verify that they have the latest versions of the related software.

Table 1. EVM Kit Contents

Item	Quantity
TMP144EVM	1

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3 EVM Hardware

3.1 Perforations

The perforation between USB controller and TMP144 sensors is labelled on both sides for pin connections.

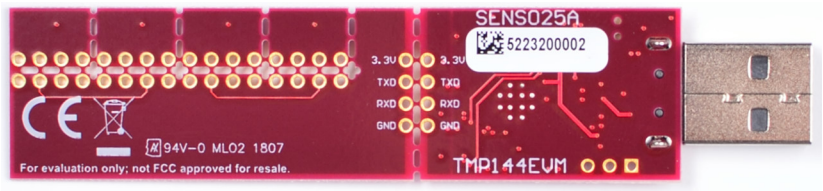


Figure 1. TMP144EVM

Figure 2 shows the pin connections on the individual TMP144 boards.

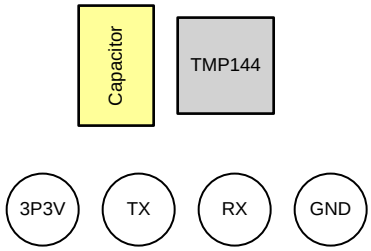


Figure 2. TMP144EVM Pin Connections

3.2 Subregulator

The switch S1 enables and disables the onboard 3.3-V subregulator U5.When the subregulator is enabled, the green LED D2 illuminates. The subregulator must be enabled for normal operation of TMP144EVM.

3.3 Logic Level Translators

The translators U9 and U10 separate the MSP430 UART host from the TMP144 devices. This is not required for end-applications, but is provided on the EVM as a courtesy. When the subregulator is disabled, a voltage between 1.4-3.6V can be applied at the 3P3V net which is 3.3-V pin on the perforation. This external voltage will illuminate the green LED D2 and power the TMP144 devices.

3.4 Programming Header

The TMP144EVM comes pre-loaded with firmware that is necessary for the correct operation of the USB interface and PC GUI software. The unpopulated header, J2, is provided for Spy-Bi-Wire access to the MSP430F5528. TI does not recommend for users to access this header or reprogram the device.

3.4.1 BSL Button

The TMP144EVM features push-button SW1 for entering USB BSL mode. This mode can be used for firmware updates. This feature is not currently supported by TMP144EVM.

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4 Software Download

The PC GUI Software for TMP144EVM runs on TI's GUI Composer framework. The software is available as a live version which runs in your browser, and it is available as a download for offline use. The software is compatible with Windows, Mac and Linux operating systems.

4.1 Live Software on dev.ti.com

The Live software currently works on Chrome, Firefox, and Safari browsers. Internet Explorer is not supported. Users can access the Live version by visiting one of the following:

- Go to the EVM tool page and click on the View button
- Go to dev.ti.com/gallery and search for TMP144EVM

Click on the application icon within Gallery to launch the software. Click on the prompt to install the TI Cloud Agent Bridge browser plugin.

4.2 Offline Software

4.2.1 Download From dev.ti.com

Users can access the latest version of the offline software by navigating to the live version as noted above. Look for the download icon and download both the application and runtime for the operating system as shown in Figure 3.

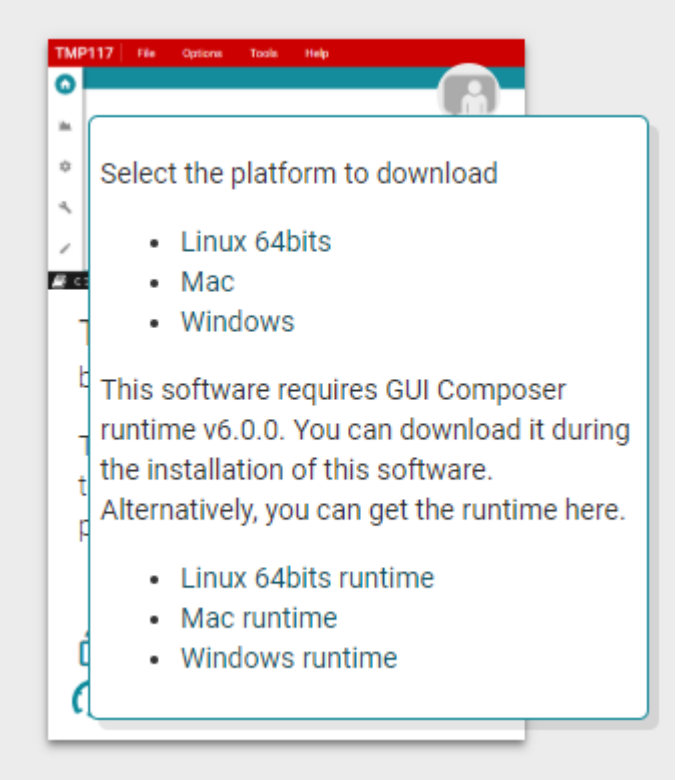


Figure 3. Download Platforms

4.2.2 Download From EVM Tool page

A software installer is provided for the Windows operating system. Navigate to the EVM tool page and click the Download link.

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5 Software

5.1 Home Tab

The Home Tab in Figure 4 is shown at software launch. The Learn More link displays Features and Functional Diagram for the TMP144 device. The icons are shortcuts to the tabs shown on the left side of the screen.

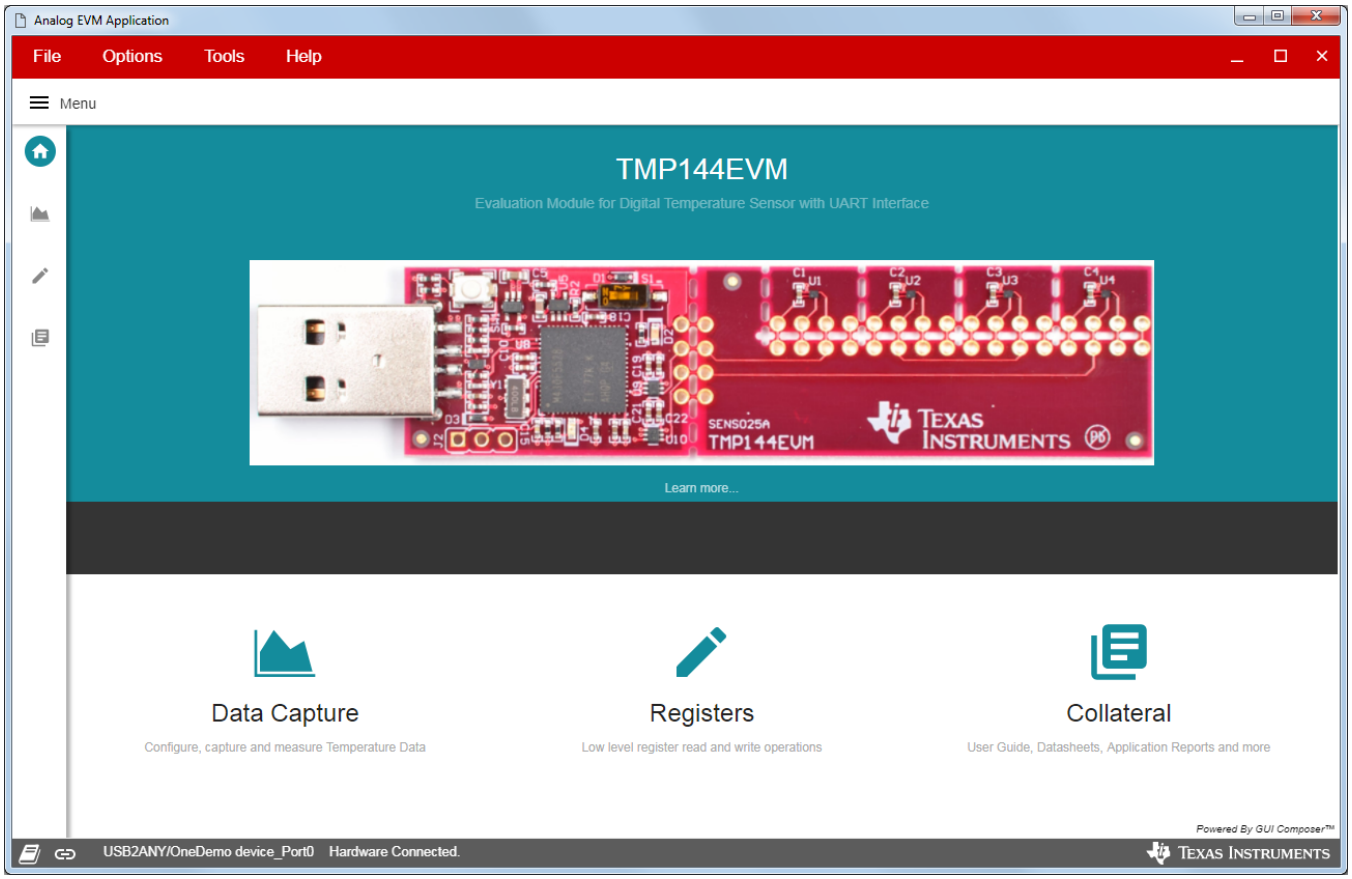


Figure 4. Home Tab

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5.2 Data Capture Tab

The Data Capture tab shown in Figure 5 reports the temperature from each of the four TMP144 devices included on the TMP144EVM. To enable Data Capture, select an Auto Read setting at the top of the Registers tab.

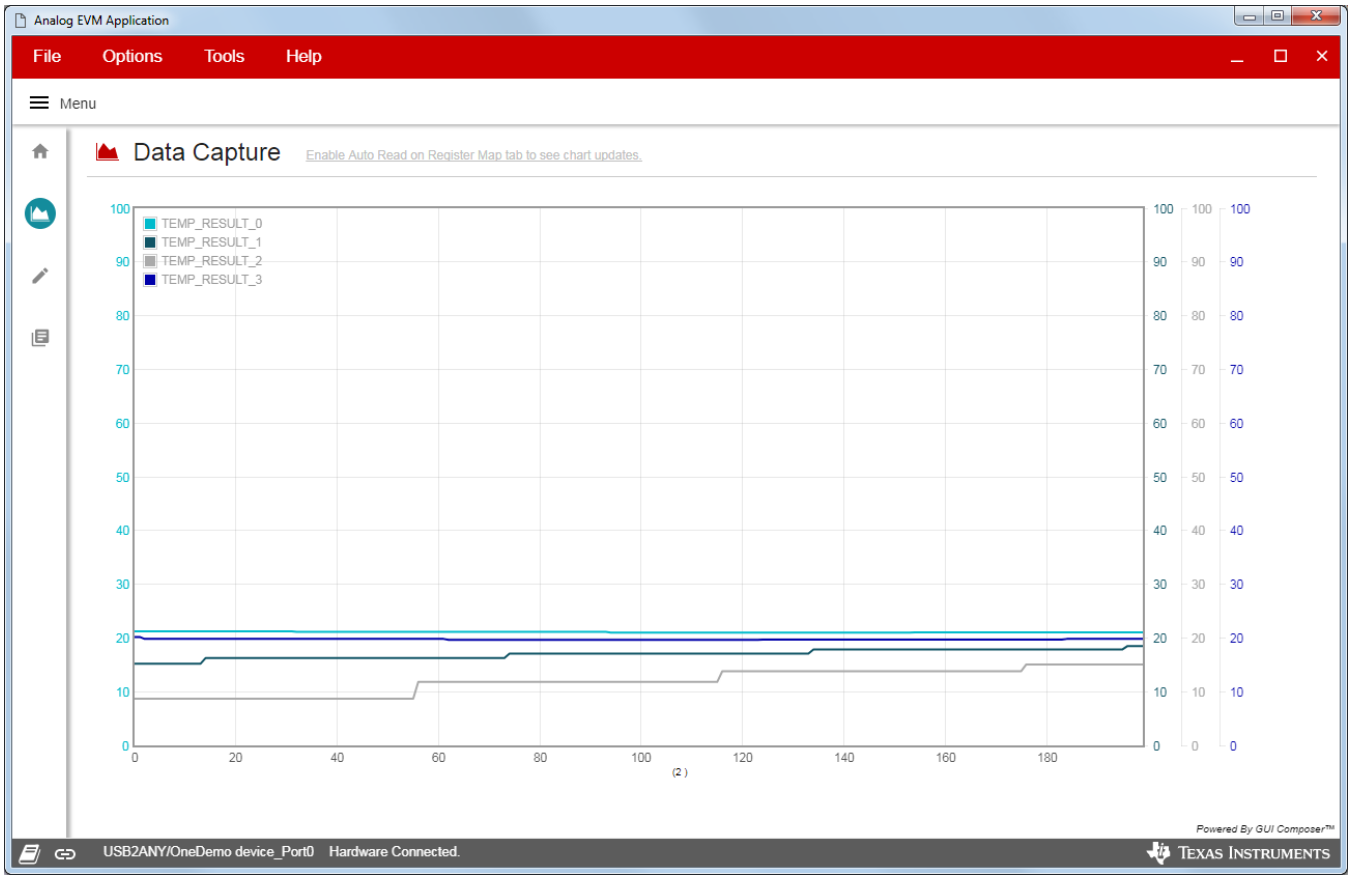


Figure 5. Data Capture Tab

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5.3 Registers Tab

The Registers tab shown in Figure 6 interacts with the registers and bits within the four TMP144 devices. By default, interacting with a register will trigger a Global Write operation on the SMAART bus. This will change the settings of all devices on the bus. To interact with a single device, change the Read/Write dropdown to Individual. This will cause all SMAART transactions to address individual TMP144 devices on the bus.

The Auto Read drop down box configures polling of register contents. When Auto Read is Off, it is necessary to click Read Register to fetch the contents of the current register. Read All Registers can be used to fetch the contents of all registers at once. The Write Register button is greyed and disabled when the drop-down next to the button is set to Immediate. Immediate mode triggers a Write operation each time a register is modified. When Deferred mode is selected, the Write Register button is enabled, and write operations will not be performed unless the Write Register button is clicked.

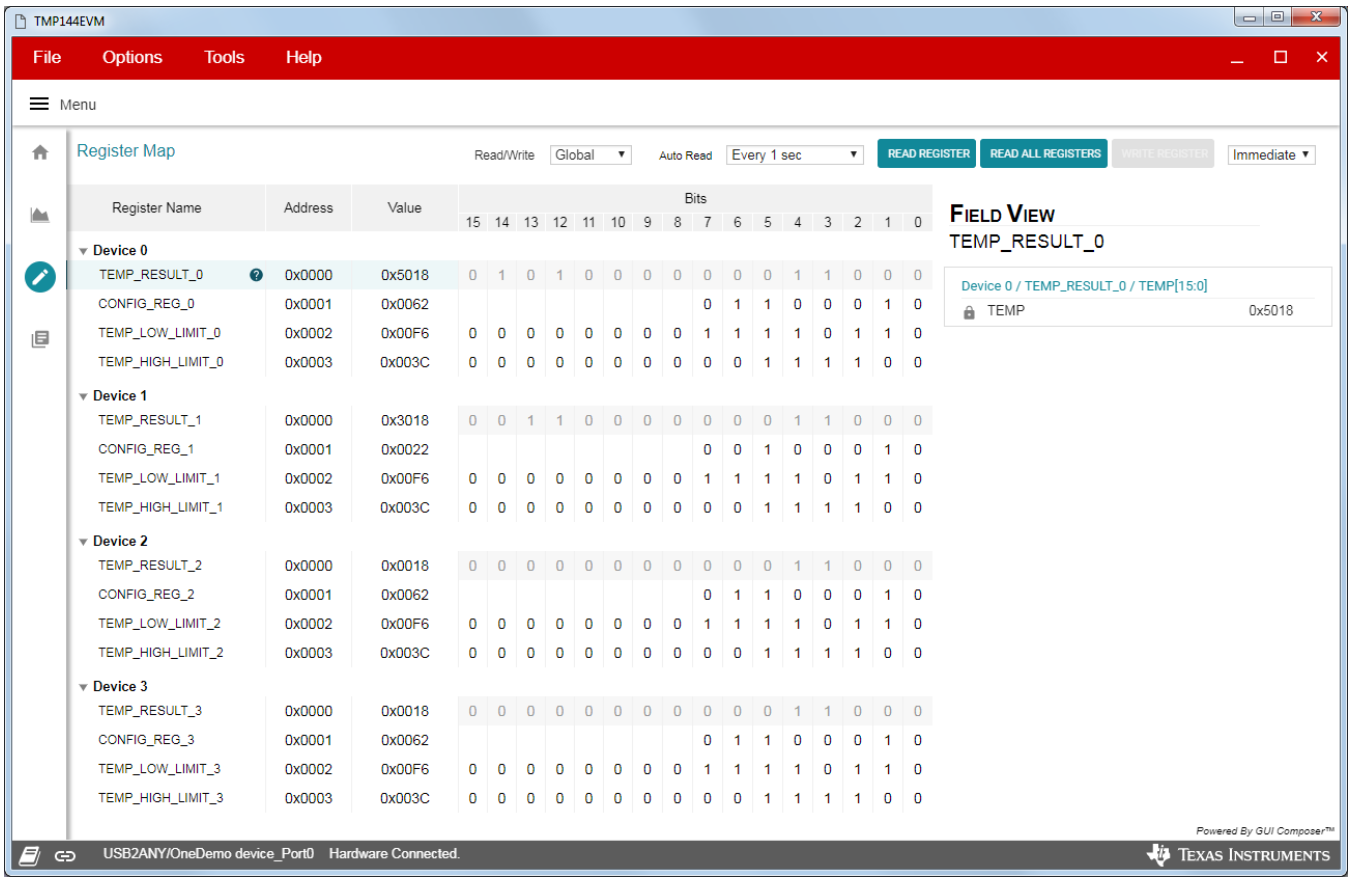


Figure 6. Registers Tab

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5.4 Collateral Tab

The Collateral Tab shown in Figure 7 contains links to the EVM User's guide, the Tool page on ti.com, as well as links to the product datasheet and other relevant links.

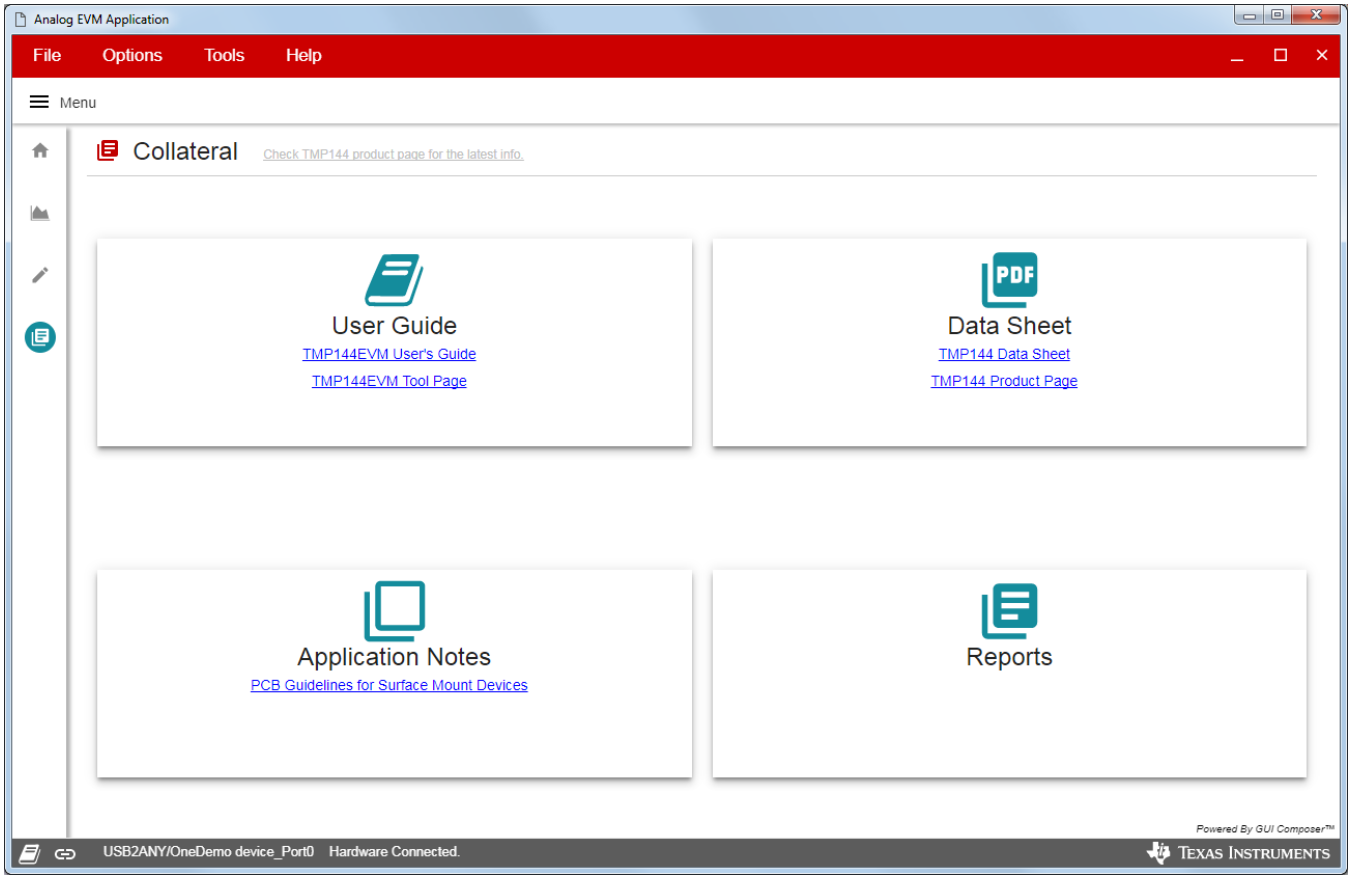


Figure 7. Collateral Tab

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6 Schematic, Board Layout, and Bill of Materials

6.1 Schematic

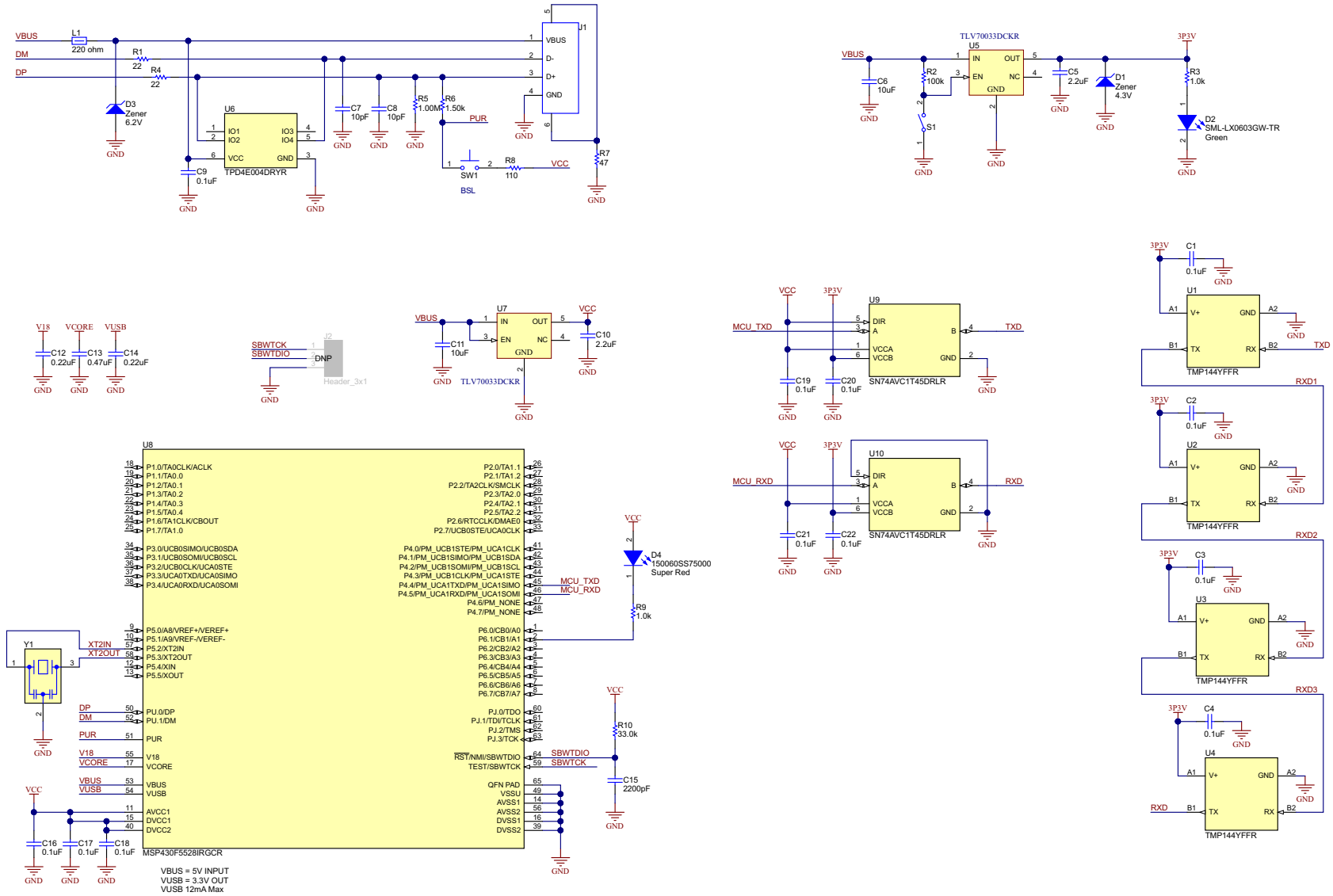


Figure 8. Schematic

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6.2 Printed-Circuit Board

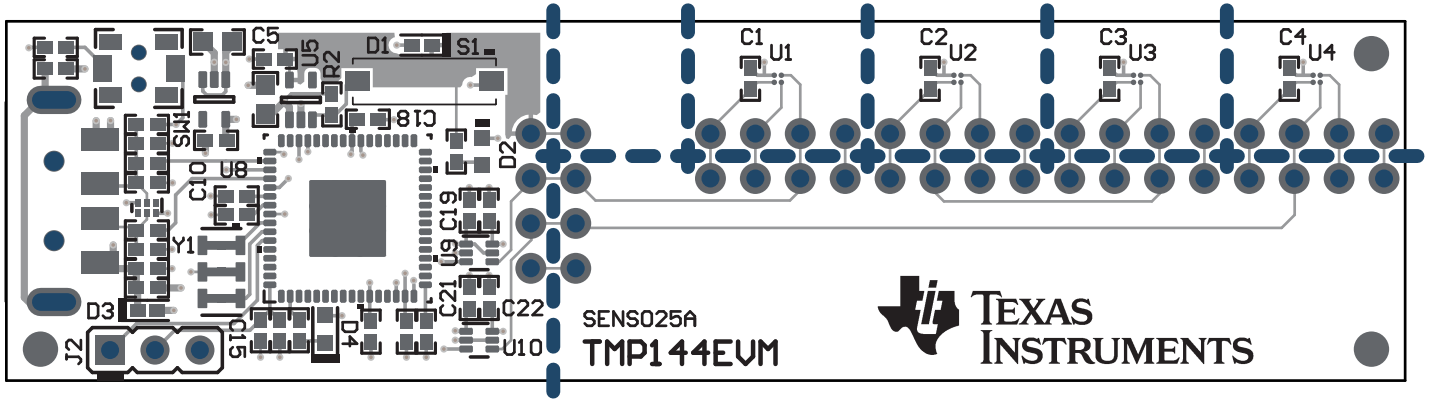


Figure 9. Printed-Circuit Board

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6.3 Bill of Materials

Table 2. Bill of Materials

Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer	Alternate Part Number	Alternate Manufacturer
!PCB	1		Printed Circuit Board		SENS025	Any		
C1, C2, C3, C4, C9, C16, C17, C18, C19, C20, C21, C22	12	0.1uF	CAP, CERM, 0.1 uF, 16 V, +/- 5%, X7R, 0402	0402	GRM155R71C104JA88D	MuRata		
C5, C10	2	2.2uF	CAP, CERM, 2.2 uF, 16 V, +/- 10%, X5R, 0402	0402	GRM155R61C225KE11D	MuRata		
C6, C11	2	10uF	CAP, CERM, 10 uF, 10 V, +/- 20%, X5R, 0603	0603	C1608X5R1A106M080AC	TDK		
C7, C8	2	10pF	CAP, CERM, 10 pF, 50 V, +/- 5%, C0G/NP0, 0402	0402	GRM1555C1H100JA01D	MuRata		
C12, C14	2	0.22uF	CAP, CERM, 0.22 uF, 25 V, +/- 20%, X5R, 0402	0402	C1005X5R1E224M050BC	TDK		
C13	1	0.47uF	CAP, CERM, 0.47 uF, 10 V, +/- 10%, X5R, 0402	0402	GRM155R61A474KE15D	MuRata		
C15	1	2200pF	CAP, CERM, 2200 pF, 6.3 V, +/- 10%, X5R, 0402	0402	GRM155R60J222KA01D	MuRata		
D1	1	4.3V	Diode, Zener, 4.3 V, 300 mW, SOD-523	SOD-523	BZT52C4V3T-7	Diodes Inc.		
D2	1	Green	Diode, Zener, 4.3 V, 300 mW, SOD-523	LED, GREEN, 0603	SML-LX0603GW-TR	Lumex		
D3	1	6.2V	Diode, Zener, 6.2 V, 300 mW, SOD-523	SOD-523	BZT52C6V2T-7	Diodes Inc.		
D4	1	Super Red	LED, Super Red, SMD	LED_0603	150060SS75000	Wurth Elektronik		
J1	1		Connector, Plug, USB Type A, R/A, Top Mount SMT	USB Type A right angle	48037-1000	Molex		
L1	1	220 ohm	Ferrite Bead, 220 ohm @ 100 MHz, 0.45 A, 0402	0402	BLM15AG221SN1D	MuRata		
R1, R4	2	22	RES, 22, 5%, 0.1 W, AEC-Q200 Grade 0, 0402	0402	ERJ-2GEJ220X	Panasonic		
R2	1	100k	RES, 100 k, 5%, 0.1 W, AEC-Q200 Grade 0, 0402	0402	ERJ-2GEJ104X	Panasonic		

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Table 2. Bill of Materials (continued)

Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer	Alternate Part Number	Alternate Manufacturer
R3, R9	2	1.0k	RES, 1.0 k, 5%, 0.1 W, AEC-Q200 Grade 0, 0402	0402	ERJ-2GEJ102X	Panasonic		
R5	1	1.00Meg	RES, 1.00 M, 1%, 0.063 W, AEC-Q200 Grade 0, 0402	0402	RMCF0402FT1M00	Stackpole Electronics Inc		
R6	1	1.50k	RES, 1.50 k, 1%, 0.063 W, AEC-Q200 Grade 0, 0402	0402	RMCF0402FT1K50	Stackpole Electronics Inc		
R7	1	47	RES, 47, 5%, 0.1 W, AEC-Q200 Grade 0, 0402	0402	ERJ-2GEJ470X	Panasonic		
R8	1	110	RES, 110, 1%, 0.1 W, AEC-Q200 Grade 0, 0402	0402	ERJ-2RKF1100X	Panasonic		
R10	1	33.0k	RES, 33.0 k, 1%, 0.063 W, 0402	0402	RC0402FR-0733KL	Yageo America		
S1	1		Switch, Slide, SPST, Top Slide, SMT	Switch, Single Top Slide, 2.5x8x2.5mm	CHS-01TB	Copal Electronics		
SW1	1		Switch, SPST-NO, Off-Mom, 0.05A, 12VDC, SMD	3.9x2.9mm	PTS820 J20M SMTR LFS	C&K Components		
U1, U2, U3, U4	4		Low-Power, Digital Temperature Sensor with SMAART Wire(TM) Interface, YFF0004AAAJ (DSBGA-4)	YFF0004AAAJ	TMP144YFFR	Texas Instruments		Texas Instruments
U5, U7	2		Single Output LDO, 200 mA, Fixed 3.3 V Output, 2 to 5.5 V Input, with Low IQ, 5-pin SC70 (DCK), -40 to 125 degC, Green (RoHS & no Sb/Br)	DCK0005A	TLV70033DCKR	Texas Instruments		
U6	1		ESD-Protection Array for High-Speed Data Interfaces, 4 Channels, -40 to +85 degC, 6-pin SON (DRY), Green (RoHS & no Sb/Br)	DRY0006A	TPD4E004DRYR	Texas Instruments		

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Table 2. Bill of Materials (continued)

Designator	Quantity	Value	Description	Package Reference	Part Number	Manufacturer	Alternate Part Number	Alternate Manufacturer
U8	1		25 MHz Mixed Signal Microcontroller with 128 KB Flash, 8192 B SRAM and 47 GPIOs, -40 to 85 degC, 64-pin QFN (RGC), Green (RoHS & no Sb/Br)	RGC0064B	MSP430F5528IRGCR	Texas Instruments		
U9, U10	2		Single-Bit Dual-Supply Bus Transceiver with Configurable Voltage Translation and 3-State Outputs, DRL0006A, LARGE T&R	DRL0006A	SN74AVC1T45DRLR	Texas Instruments		Texas Instruments
Y1	1		Resonator, 4 MHz, 5000 ppm, SMD	4.5x2mm	PBRC4.00MR50X000	AVX		
J2	0		Header, 2.54 mm, 3x1, Gold, TH	Header, 2.54 mm, 3x1, TH	GBC03SAAN	Sullins Connector Solutions		

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   1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.

2 *Limited Warranty and Related Remedies/Disclaimers*:

   2.1 These terms do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.

   2.2 TI warrants that the TI EVM will conform to TI's published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for a nonconforming EVM if (a) the nonconformity was caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI, (b) the nonconformity resulted from User's design, specifications or instructions for such EVMs or improper system design, or (c) User has not paid on time. Testing and other quality control techniques are used to the extent TI deems necessary. TI does not test all parameters of each EVM. User's claims against TI under this Section 2 are void if User fails to notify TI of any apparent defects in the EVMs within ten (10) business days after delivery, or of any hidden defects with ten (10) business days after the defect has been detected.

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3 *Regulatory Notices:*

   3.1 *United States*

      3.1.1 *Notice applicable to EVMs not FCC-Approved:*

      FCC NOTICE: This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

      3.1.2 *For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:*

      CAUTION

      This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

      Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

      FCC Interference Statement for Class A EVM devices

      NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- *Reorient or relocate the receiving antenna.*
- *Increase the separation between the equipment and receiver.*
- *Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.*
- *Consult the dealer or an experienced radio/TV technician for help.*

3.2 *Canada*

3.2.1 *For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247*

Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSSs. Operation is subject to the following two conditions:

(1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Concerning EVMs Including Detachable Antennas:

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

3.3 *Japan*

3.3.1 *Notice for EVMs delivered in Japan:* Please see http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_01.page 日本国内に輸入される評価用キット、ボードについては、次のところをご覧ください。
http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_01.page

3.3.2 *Notice for Users of EVMs Considered "Radio Frequency Products" in Japan:* EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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1. 電波法施行規則第6条第1項第1号に基づく平成18年3月28日総務省告示第173号で定められた電波暗室等の試験設備でご使用いただく。
2. 実験局の免許を取得後ご使用いただく。
3. 技術基準適合証明を取得後ご使用いただく。

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西新宿三井ビル

3.3.3 *Notice for EVMs for Power Line Communication:* Please see http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_02.page

電力線搬送波通信についての開発キットをお使いになる際の注意事項については、次のところをご覧ください。http://www.tij.co.jp/lsds/ti_ja/general/eStore/notice_02.page

3.4 *European Union*

3.4.1 *For EVMs subject to EU Directive 2014/30/EU (Electromagnetic Compatibility Directive)*:

This is a class A product intended for use in environments other than domestic environments that are connected to a low-voltage power-supply network that supplies buildings used for domestic purposes. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

4 *EVM Use Restrictions and Warnings:*

4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.

4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.

4.3 *Safety-Related Warnings and Restrictions:*

4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.

4.3.2 EVMs are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems. User assumes all responsibility and liability for proper and safe handling and use of the EVM by User or its employees, affiliates, contractors or designees. User assumes all responsibility and liability to ensure that any interfaces (electronic and/or mechanical) between the EVM and any human body are designed with suitable isolation and means to safely limit accessible leakage currents to minimize the risk of electrical shock hazard. User assumes all responsibility and liability for any improper or unsafe handling or use of the EVM by User or its employees, affiliates, contractors or designees.

4.4 User assumes all responsibility and liability to determine whether the EVM is subject to any applicable international, federal, state, or local laws and regulations related to User's handling and use of the EVM and, if applicable, User assumes all responsibility and liability for compliance in all respects with such laws and regulations. User assumes all responsibility and liability for proper disposal and recycling of the EVM consistent with all applicable international, federal, state, and local requirements.

5. *Accuracy of Information:* To the extent TI provides information on the availability and function of EVMs, TI attempts to be as accurate as possible. However, TI does not warrant the accuracy of EVM descriptions, EVM availability or other information on its websites as accurate, complete, reliable, current, or error-free.

6. *Disclaimers:*

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8. *Limitations on Damages and Liability:*

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9. *Return Policy.* Except as otherwise provided, TI does not offer any refunds, returns, or exchanges. Furthermore, no return of EVM(s) will be accepted if the package has been opened and no return of the EVM(s) will be accepted if they are damaged or otherwise not in a resalable condition. If User feels it has been incorrectly charged for the EVM(s) it ordered or that delivery violates the applicable order, User should contact TI. All refunds will be made in full within thirty (30) working days from the return of the components(s), excluding any postage or packaging costs.

10. *Governing Law:* These terms and conditions shall be governed by and interpreted in accordance with the laws of the State of Texas, without reference to conflict-of-laws principles. User agrees that non-exclusive jurisdiction for any dispute arising out of or relating to these terms and conditions lies within courts located in the State of Texas and consents to venue in Dallas County, Texas. Notwithstanding the foregoing, any judgment may be enforced in any United States or foreign court, and TI may seek injunctive relief in any United States or foreign court.

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